

## Team takes a deep look at memristors

January 19 2018

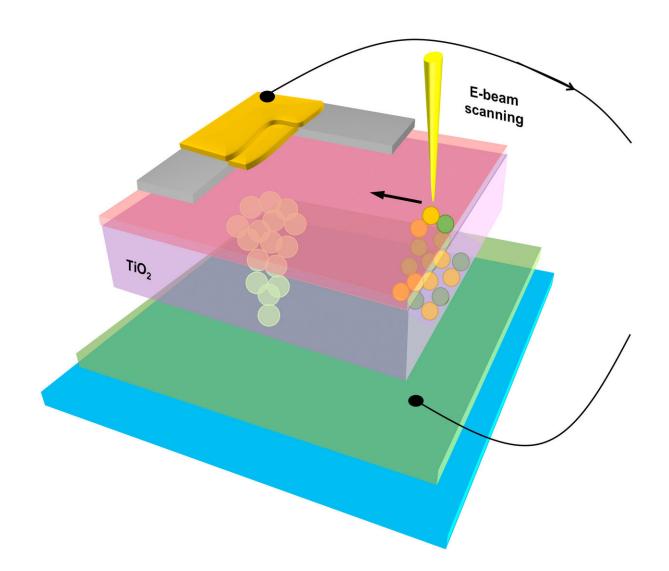


Illustration shows an electron beam impinging on a section of a memristor, a device whose resistance depends on the memory of past current flow. As the beam strikes different parts of the memristor, it induces different currents, yielding a complete image of variations in the current throughout the device. Some of these variations in current indicate places where defects may occur,



indicated by overlapping circles in the filament (titanium dioxide), where memory is stored. Credit: NIST

In the race to build a computer that mimics the massive computational power of the human brain, researchers are increasingly turning to memristors, which can vary their electrical resistance based on the memory of past activity. Scientists at the National Institute of Standards and Technology (NIST) have now unveiled the long-mysterious inner workings of these semiconductor elements, which can act like the shortterm memory of nerve cells.

Just as the ability of one nerve cell to signal another depends on how often the cells have communicated in the recent past, the resistance of a memristor depends on the amount of current that recently flowed through it. Moreover, a memristor retains that memory even when electrical power is switched off.

But despite the keen interest in memristors, scientists have lacked a detailed understanding of how these devices work and have yet to develop a standard toolset to study them.

Now, NIST scientists have identified such a toolset and used it to more deeply probe how memristors operate. Their findings could lead to more efficient operation of the devices and suggest ways to minimize the leakage of current.

Brian Hoskins of NIST and the University of California, Santa Barbara, along with NIST scientists Nikolai Zhitenev, Andrei Kolmakov, Jabez McClelland and their colleagues from the University of Maryland's NanoCenter in College Park and the Institute for Research and Development in Microtechnologies in Bucharest, reported the findings in



## a recent Nature Communications.

To explore the electrical function of memristors, the team aimed a tightly focused beam of electrons at different locations on a titanium dioxide memristor. The beam knocked free some of the <u>device</u>'s electrons, which formed ultrasharp images of those locations. The beam also induced four distinct currents to flow within the device. The team determined that the currents are associated with the multiple interfaces between materials in the memristor, which consists of two metal (conducting) layers separated by an insulator.

"We know exactly where each of the currents are coming from because we are controlling the location of the beam that is inducing those currents," said Hoskins.

In imaging the device, the team found several dark spots—regions of enhanced conductivity—which indicated places where current might leak out of the memristor during its normal operation. These leakage pathways resided outside the memristor's core—where it switches between the low and high resistance levels that are useful in an electronic device. The finding suggests that reducing the size of a memristor could minimize or even eliminate some of the unwanted current pathways. Although researchers had suspected that might be the case, they had lacked experimental guidance about just how much to reduce the size of the device.

Because the leakage pathways are tiny, involving distances of only 100 to 300 nanometers, "you're probably not going to start seeing some really big improvements until you reduce dimensions of the memristor on that scale," Hoskins said.

To their surprise, the team also found that the current that correlated with the memristor's switch in resistance didn't come from the active



switching material at all, but the metal layer above it. The most important lesson of the <u>memristor</u> study, Hoskins noted, "is that you can't just worry about the resistive switch, the switching spot itself, you have to worry about everything around it." The team's study, he added, "is a way of generating much stronger intuition about what might be a good way to engineer memristors."

**More information:** Brian D. Hoskins et al, Stateful characterization of resistive switching TiO2 with electron beam induced currents, *Nature Communications* (2017). DOI: 10.1038/s41467-017-02116-9

This story is republished courtesy of NIST. Read the original story here.

Provided by National Institute of Standards and Technology

Citation: Team takes a deep look at memristors (2018, January 19) retrieved 19 April 2024 from <u>https://phys.org/news/2018-01-team-deep-memristors.html</u>

This document is subject to copyright. Apart from any fair dealing for the purpose of private study or research, no part may be reproduced without the written permission. The content is provided for information purposes only.